

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of Applicants:

B. S. Beaman et al.

Serial No.: 09/972,622

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For: HIGH DENSITY INTEGRAL TEST PROBE AND FABRICATION METHOD

Assistant Commissioner for Patents
Washington, D. C. 20231

Date: December 6, 2002

Group Art Unit: 3729

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CFR 1.61(d) to the U.S. Patent and Trademark Office to (703) 872-9302 on December
6, 2002.


Dr. Daniel P. Morris, Esq.
Reg. No. 32,053RESPONSE TO RESTRICTION REQUIREMENT
DATED SEPTEMBER 25, 2002

Remarks

Applicants elect, without traverse, Group I (claims 1-15).

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